

$V_{RSM} = 150\text{ V}$, $I_{F(AV)} = 20\text{ A}$
Schottky Diode
FMET-22015

Description

The FMET-22015 is a 150 V, 20 A Schottky diode with a trench structure, allowing improvements in VF and IR characteristics. These characteristic features contribute to improving power supply efficiency and to enabling high-frequency systems.

Features

- V_{RSM} ----- 150 V
- $I_{F(AV)}$ ----- 20 A
- $V_F (I_F = 10\text{ A})$ ----- 0.9 V typ.
- RoHS Compliant

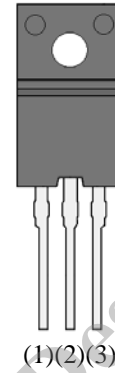
Applications

The high speed switching applications as follows:

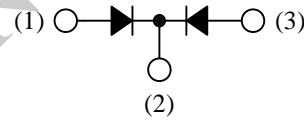
- DC-DC Converter
- Adapter

Package

TO220F-3L



Not to scale



- (1) Anode
- (2) Cathode
- (3) Anode

Not Recommended for New Designs

Absolute Maximum Ratings

 Unless otherwise specified, $T_A = 25\text{ }^\circ\text{C}$.

Parameter	Symbol	Rating	Unit	Conditions
Peak Repetitive Reverse Voltage ⁽¹⁾	V_{RSM}	150	V	
Repetitive Reverse Voltage ⁽¹⁾	V_{RM}	150	V	
Average Forward Current ⁽²⁾	$I_{F(AV)}$	20	A	See Figure 1 and Figure 2
Surge Forward Current ⁽¹⁾	I_{FSM}	120	A	Half cycle sine wave, positive side, 10 ms, 1 shot
I^2t Limiting Value ⁽¹⁾	I^2t	72	A^2s	
Junction Temperature	T_J	-40 to 150	$^\circ\text{C}$	
Storage Temperature	T_{STG}	-40 to 150	$^\circ\text{C}$	

Electrical Characteristics

 Unless otherwise specified, $T_A = 25\text{ }^\circ\text{C}$.

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage Drop ⁽¹⁾	V_F	$I_F = 10\text{ A}$	—	0.9	0.98	V
Reverse Leakage Current ⁽¹⁾	I_R	$V_R = V_{RM}$	—	—	100	μA
Reverse Leakage Current under High Temperature ⁽¹⁾	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150\text{ }^\circ\text{C}$	—	—	50	mA
Thermal Resistance ⁽³⁾	$R_{th(J-C)}$		—	—	4.0	$^\circ\text{C/W}$

⁽¹⁾ Specifies a value per chip; the FMET-22015 consists of two chips.

⁽²⁾ Specifies a value of the two chips configuring the product; a value per chip is 10 A.

⁽³⁾ $R_{th(J-C)}$ is thermal resistance between junction and the case. The case temperature is measured at the back side near the screw hole.

Rating and Characteristic Curves

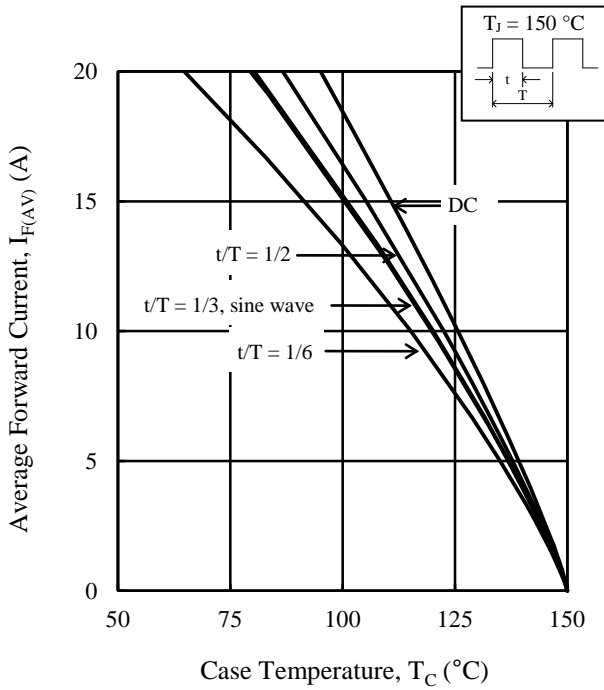


Figure 1. T_C vs. $I_{F(AV)}$ Typical Characteristics ($V_R = 0\text{ V}$)

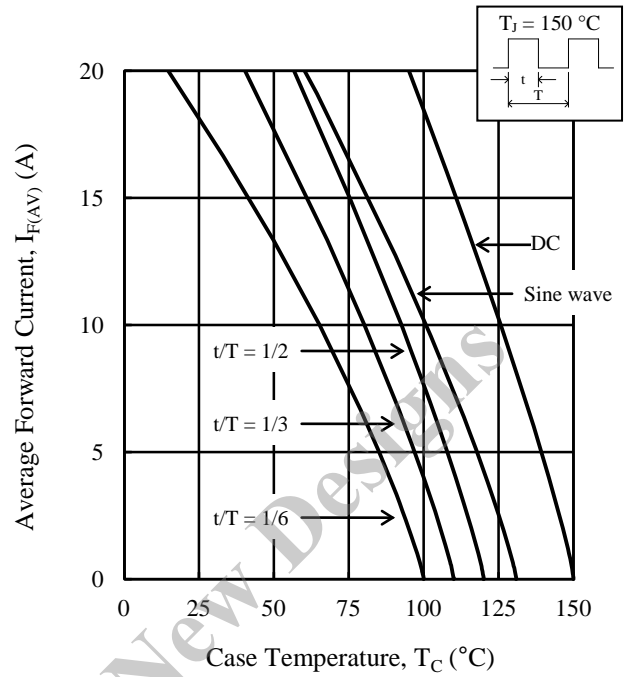


Figure 2. T_C vs. $I_{F(AV)}$ Typical Characteristics ($V_R = 150\text{ V}$)

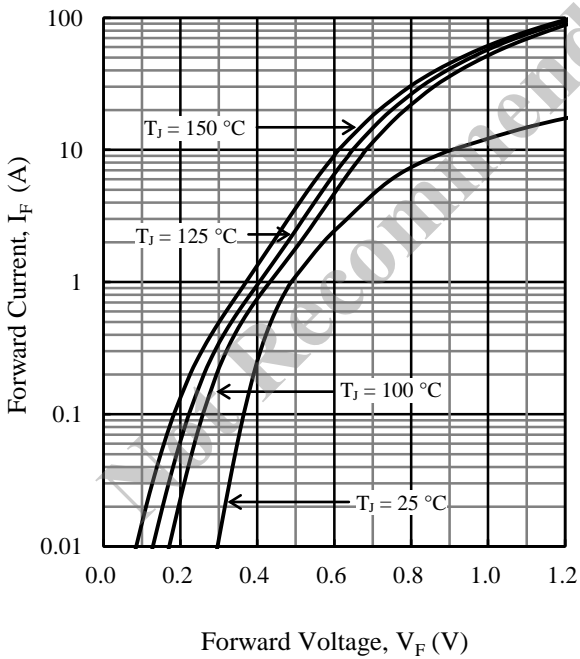


Figure 3. V_F vs. I_F Typical Characteristics

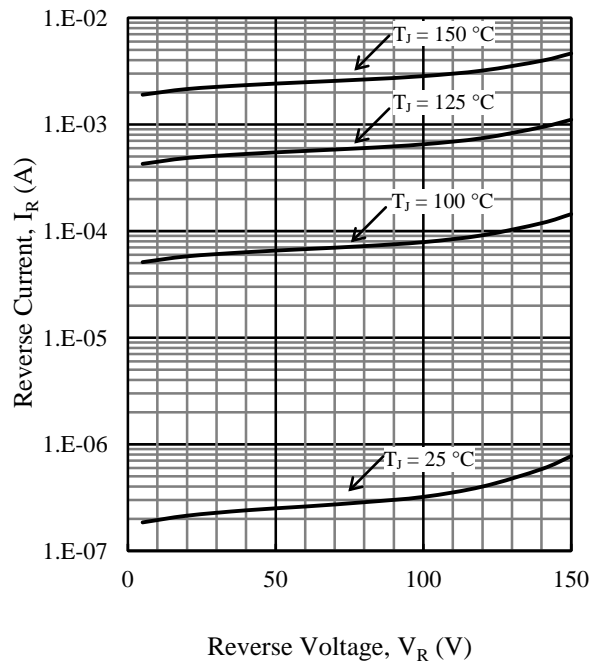
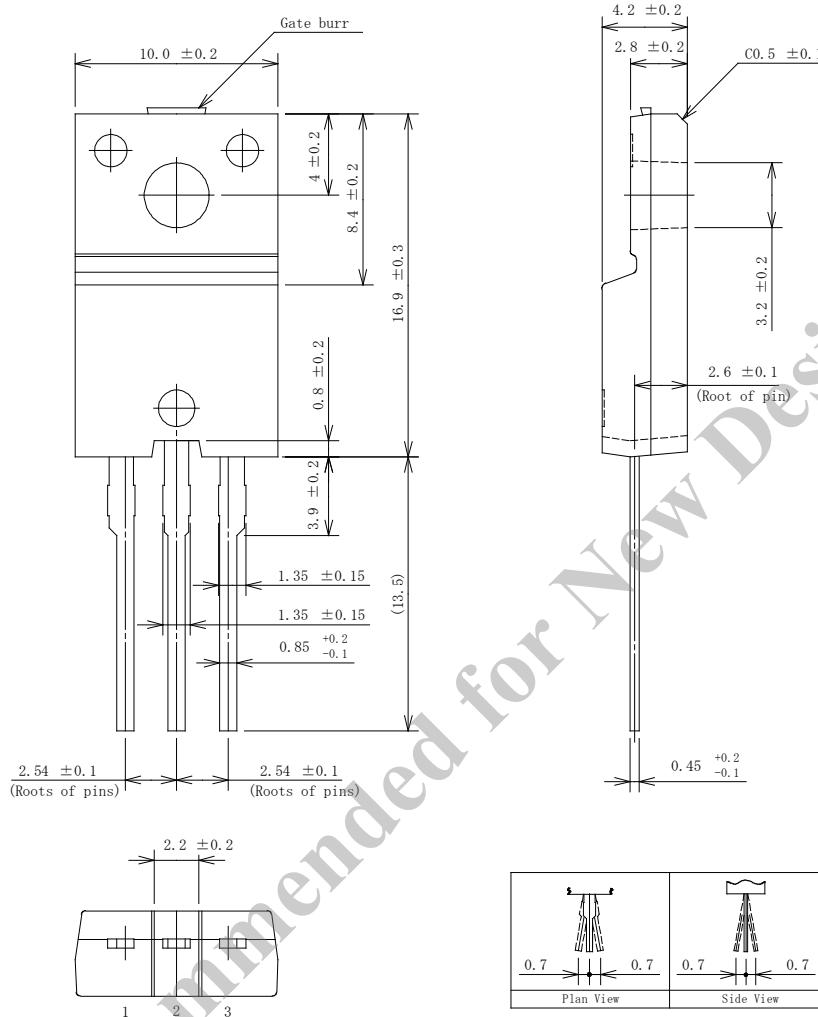


Figure 4. V_R vs. I_R Typical Characteristics

Physical Dimensions

• TO220F



NOTES:

- Dimensions in millimeters
- Maximum gate burr height is 0.3 mm.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time, within the following limits:
 - Flow: $260 \pm 5 \text{ }^\circ\text{C} / 10 \pm 1 \text{ s}$, 2 times
 - Soldering Iron: $380 \pm 10 \text{ }^\circ\text{C} / 3.5 \pm 0.5 \text{ s}$, 1 time (Soldering should be at a distance of at least 1.5 mm from the body of the product.)
 - Recommended screw torque for TO220F: 0.490 N·m to 0.686 N·m (5 kgf·cm to 7 kgf·cm)

Marking Diagram

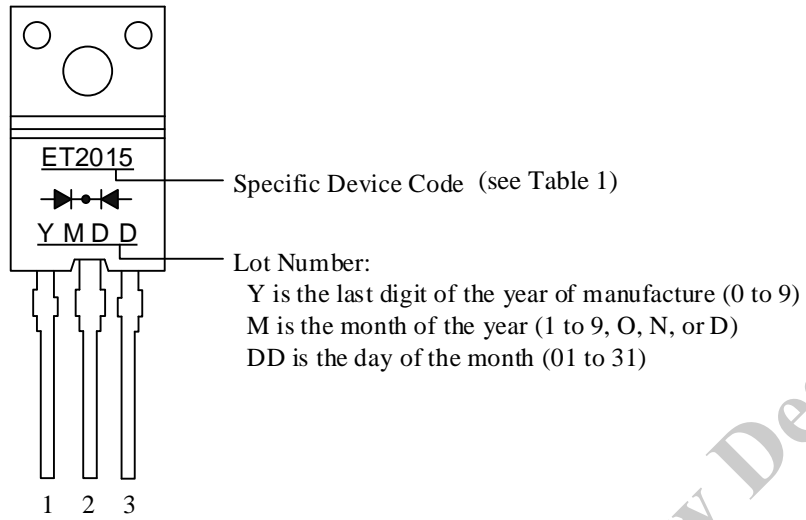


Table 1. Specific Device Code

Specific Device Code	Part Number
ET2015	FMET-22015

Not Recommended for New Designs

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